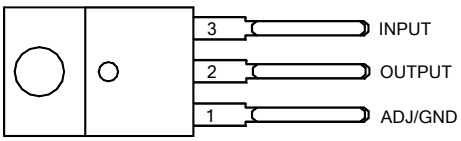
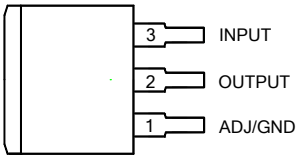
Pin Configuration

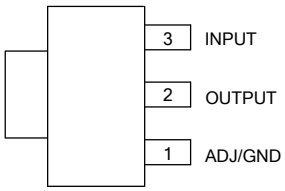
T Package
(TO-220-3)



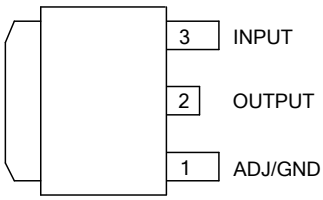
S Package
(TO-263-3)



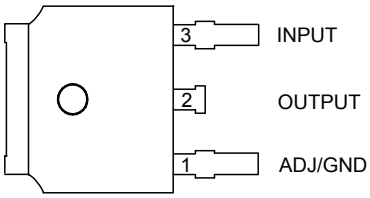
H Package
(SOT-223)



(TO-252-2 (1))



D Package
(TO-252-2 (3))



(TO-252-2 (4))

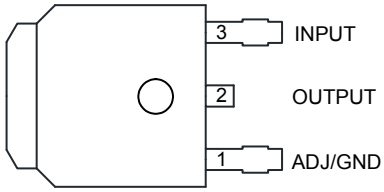


Figure 2. Pin Configuration of AZ1086 (Top View)

Functional Block Diagram

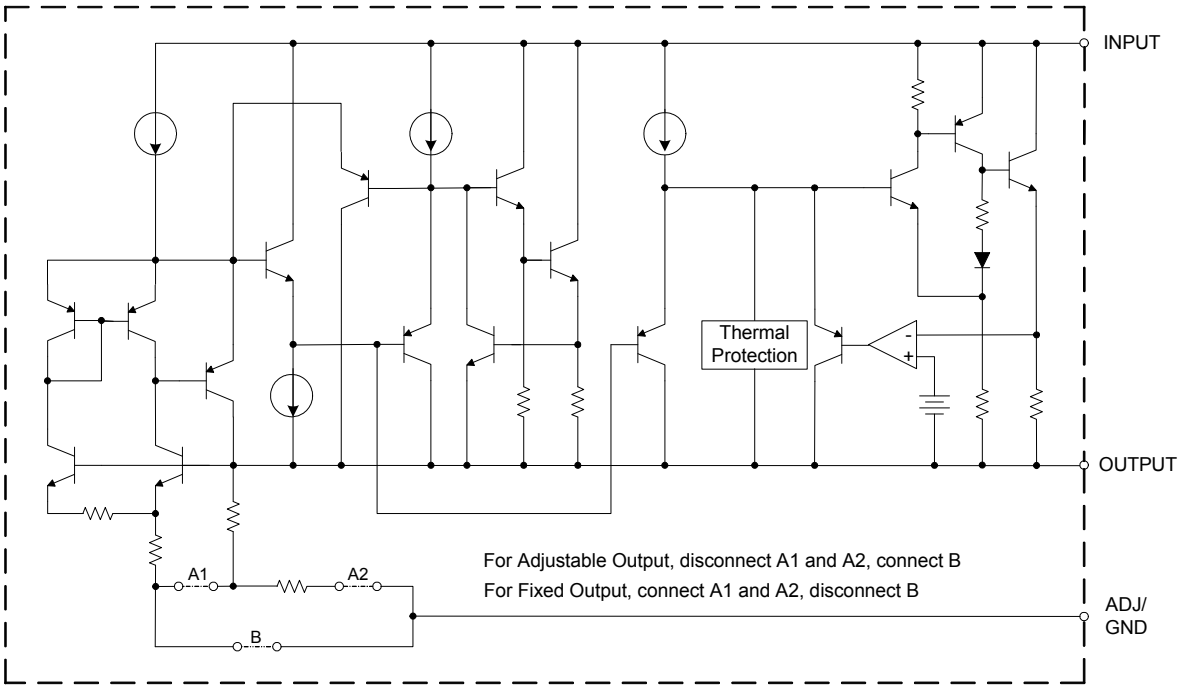
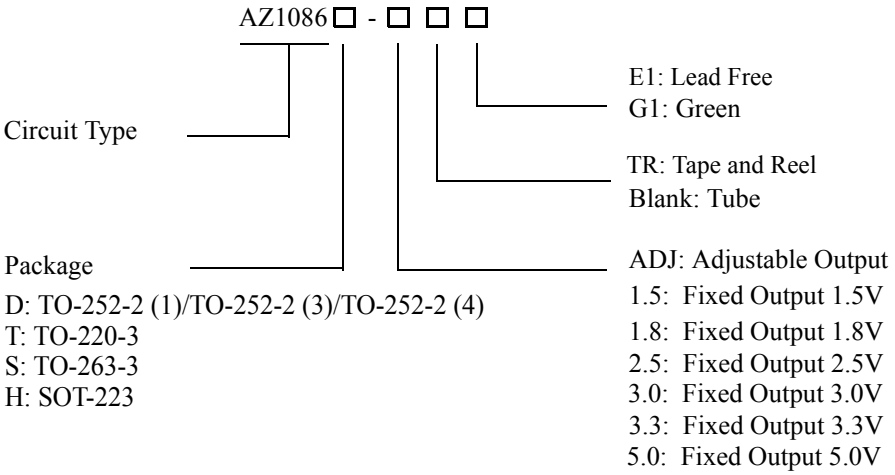


Figure 3. Functional Block Diagram of AZ1086

Ordering Information



Package	Tempera-ture Range	Part Number		Marking ID		Packing Type
		Lead Free	Green	Lead Free	Green	
TO-252-2 (1)/ TO-252-2 (3)/ TO-252-2 (4)	0 to 125°C	AZ1086D-ADJTRE1	AZ1086D-ADJTRG1	AZ1086D-ADJE1	AZ1086D-ADJG1	Tape & Reel
		AZ1086D-1.5TRE1	AZ1086D-1.5TRG1	AZ1086D-1.5E1	AZ1086D-1.5G1	Tape & Reel
		AZ1086D-1.8TRE1	AZ1086D-1.8TRG1	AZ1086D-1.8E1	AZ1086D-1.8G1	Tape & Reel
		AZ1086D-2.5TRE1	AZ1086D-2.5TRG1	AZ1086D-2.5E1	AZ1086D-2.5G1	Tape & Reel
		AZ1086D-3.0TRE1	AZ1086D-3.0TRG1	AZ1086D-3.0E1	AZ1086D-3.0G1	Tape & Reel
		AZ1086D-3.3TRE1	AZ1086D-3.3TRG1	AZ1086D-3.3E1	AZ1086D-3.3G1	Tape & Reel
		AZ1086D-5.0TRE1	AZ1086D-5.0TRG1	AZ1086D-5.0E1	AZ1086D-5.0G1	Tape & Reel
TO-220-3	0 to 125°C	AZ1086T-ADJE1	AZ1086T-ADJG1	AZ1086T-ADJE1	AZ1086T-ADJG1	Tube
		AZ1086T-1.5E1	AZ1086T-1.5G1	AZ1086T-1.5E1	AZ1086T-1.5G1	Tube
		AZ1086T-1.8E1	AZ1086T-1.8G1	AZ1086T-1.8E1	AZ1086T-1.8G1	Tube
		AZ1086T-2.5E1	AZ1086T-2.5G1	AZ1086T-2.5E1	AZ1086T-2.5G1	Tube
		AZ1086T-3.0E1	AZ1086T-3.0G1	AZ1086T-3.0E1	AZ1086T-3.0G1	Tube
		AZ1086T-3.3E1	AZ1086T-3.3G1	AZ1086T-3.3E1	AZ1086T-3.3G1	Tube
		AZ1086T-5.0E1	AZ1086T-5.0G1	AZ1086T-5.0E1	AZ1086T-5.0G1	Tube

Ordering Information (Continued)

Package	Tempera-ture Range	Part Number		Marking ID		Packing Type
		Lead Free	Green	Lead Free	Green	
TO-263-3	0 to 125°C	AZ1086S-ADJE1	AZ1086S-ADJG1	AZ1086S-ADJE1	AZ1086S-ADJG1	Tube
		AZ1086S-ADJTRE1	AZ1086S-ADJTRG1	AZ1086S-ADJE1	AZ1086S-ADJG1	Tape & Reel
		AZ1086S-1.5E1	AZ1086S-1.5G1	AZ1086S-1.5E1	AZ1086S-1.5G1	Tube
		AZ1086S-1.5TRE1	AZ1086S-1.5TRG1	AZ1086S-1.5E1	AZ1086S-1.5G1	Tape & Reel
		AZ1086S-1.8E1	AZ1086S-1.8G1	AZ1086S-1.8E1	AZ1086S-1.8G1	Tube
		AZ1086S-1.8TRE1	AZ1086S-1.8TRG1	AZ1086S-1.8E1	AZ1086S-1.8G1	Tape & Reel
		AZ1086S-2.5E1	AZ1086S-2.5G1	AZ1086S-2.5E1	AZ1086S-2.5G1	Tube
		AZ1086S-2.5TRE1	AZ1086S-2.5TRG1	AZ1086S-2.5E1	AZ1086S-2.5G1	Tape & Reel
		AZ1086S-3.0E1	AZ1086S-3.0G1	AZ1086S-3.0E1	AZ1086S-3.0G1	Tube
		AZ1086S-3.0TRE1	AZ1086S-3.0TRG1	AZ1086S-3.0E1	AZ1086S-3.0G1	Tape & Reel
		AZ1086S-3.3E1	AZ1086S-3.3G1	AZ1086S-3.3E1	AZ1086S-3.3G1	Tube
		AZ1086S-3.3TRE1	AZ1086S-3.3TRG1	AZ1086S-3.3E1	AZ1086S-3.3G1	Tape & Reel
		AZ1086S-5.0E1	AZ1086S-5.0G1	AZ1086S-5.0E1	AZ1086S-5.0G1	Tube
		AZ1086S-5.0TRE1	AZ1086S-5.0TRG1	AZ1086S-5.0E1	AZ1086S-5.0G1	Tape & Reel
SOT-223	0 to 125°C	AZ1086H-ADJTRE1	AZ1086H-ADJTRG1	EH86A	GH86A	Tape & Reel
		AZ1086H-1.5TRE1	AZ1086H-1.5TRG1	EH86B	GH86B	Tape & Reel
		AZ1086H-1.8TRE1	AZ1086H-1.8TRG1	EH86E	GH86E	Tape & Reel
		AZ1086H-2.5TRE1	AZ1086H-2.5TRG1	EH86C	GH86C	Tape & Reel
		AZ1086H-3.0TRE1	AZ1086H-3.0TRG1	EH86G	GH86G	Tape & Reel
		AZ1086H-3.3TRE1	AZ1086H-3.3TRG1	EH86D	GH86D	Tape & Reel
		AZ1086H-5.0TRE1	AZ1086H-5.0TRG1	EH86F	GH86F	Tape & Reel

BCD Semiconductor's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.

Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Value		Unit
Operating Junction Temperature	T_J	150		°C
Storage Temperature Range	T_{STG}	-65 to 150		°C
Lead Temperature (Soldering, 10sec)	T_{LEAD}	260		°C
Thermal Resistance (Note 2)	θ_{JA}	TO-252-2 (1)/ TO-252-2 (3)/ TO-252-2 (4)	100	°C/W
		TO-263-3	60	
		TO-220-3	60	
		SOT-223	120	
ESD (Machine Model)	ESD	400		V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Note 2: Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its operating ratings. The maximum allowable power dissipation is a function of the maximum junction temperature, $T_{J(max)}$, the junction-to-ambient thermal resistance, θ_{JA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: $P_{D(max)}=(T_{J(max)}-T_A)/\theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Input Voltage	V_{IN}		15	V
Operating Junction Temperature Range	T_J	0	125	°C

Electrical Characteristics

Typicals and limits appearing in normal type apply for T_J = 25°C. Limits appearing in **Boldface** type apply over the entire junction temperature range for operation, 0°C to 125°C. (P_D≤maximum power dissipation, see Note 3.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reference Voltage	V_{REF}	AZ1086-ADJ, I_{OUT}=10mA, V_{IN}-V_{OUT}=2V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 1.4V≤V_{IN}-V_{OUT}≤6V	1.238 **1.225**	1.250 **1.250**	1.262 **1.270**	V
Output Voltage	V_{OUT}	AZ1086-1.5, I_{OUT}=10mA, V_{IN}=3.5V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 3V≤V_{IN}≤10V	1.485 **1.47**	1.5 **1.5**	1.515 **1.53**	V
		AZ1086-1.8, I_{OUT}=10mA, V_{IN}=3.8V, T_J=25°C, 10mA≤I_{OUT}≤1. 5A, 3.2V≤V_{IN}≤10V	1.782 **1.746**	1.8 **1.8**	1.818 **1.854**	V
		AZ1086-2.5, I_{OUT}=10mA, V_{IN}=4.5V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 3.9V≤V_{IN}≤10V	2.475 **2.45**	2.5 **2.5**	2.525 **2.55**	V
		AZ1086-3.0, I_{OUT}=10mA, V_{IN}=4.5V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 4.9V≤V_{IN}≤10V	2.97 **2.94**	3.0 **3.0**	3.03 **3.06**	V
		AZ1086-3.3, I_{OUT}=10mA, V_{IN}=5V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 4.75V≤V_{IN}≤10V	3.267 **3.235**	3.3 **3.3**	3.333 **3.365**	V
		AZ1086-5.0, I_{OUT}=10mA, V_{IN}=7V, T_J=25°C, 10mA≤I_{OUT}≤1.5A, 6.5V≤V_{IN}≤10V	4.95 **4.9**	5 **5**	5.05 **5.1**	V
Line Regulation	ΔV_{OUT}	AZ1086-ADJ, I_{OUT} = 10mA, 1.5V ≤ V_{IN}-V_{OUT}≤10V		0.015 **0.035**	0.2 **0.2**	%
		AZ1086-1.5, I_{OUT}=10mA, 1.5V≤V_{IN}-V_{OUT}≤10V		0.3 **0.6**	6 **6**	mV
		AZ1086-1.8, I_{OUT}=10mA, 1.5V≤V_{IN}-V_{OUT}≤10V		0.3 **0.6**	6 **6**	mV
		AZ1086-2.5, I_{OUT}=10mA, 1.5V≤V_{IN}-V_{OUT}≤10V		0.3 **0.6**	6 **6**	mV
		AZ1086-3.0, I_{OUT}=10mA, 1.5V ≤V_{IN}-V_{OUT}≤10V		0.3 **0.6**	6 **6**	mV
		AZ1086-3.3, I_{OUT}=10mA, 1.5V≤V_{IN}-V_{OUT}≤10V		0.5 **1**	10 **10**	mV
		AZ1086-5.0, I_{OUT}=10mA, 1.5V≤V_{IN}-V_{OUT}≤10V		0.5 **1**	10 **10**	mV
Thermal Resistance, Junction to Case	θ_{JC}	TO-220-3		7.22		°C/W
		TO-252-2 (1)/TO-252-2 (3)/TO-252-2 (4)		12.81		
		TO-263-3		7.22		
		SOT-223		19.35		

Electrical Characteristics (Continued)

Typicals and limits appearing in normal type apply for T_J=25°C. Limits appearing in **Boldface** type apply over the entire junction temperature range for operation, 0°C to 125°C. (P_D≤maximum power dissipation, see Note 3.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Load Regulation	ΔV_{OUT}	AZ1086-ADJ, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		0.1 **0.2**	0.3 **0.4**	%
		AZ1086-1.5, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		3 **6**	12 **20**	mV
		AZ1086-1.8, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		3 **6**	12 **20**	mV
		AZ1086-2.5, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		3 **6**	12 **20**	mV
		AZ1086-3.0, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		3 **7**	15 **20**	mV
		AZ1086-3.3, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		3 **7**	15 **20**	mV
		AZ1086-5.0, 10mA≤I_{OUT}≤1.5A, V_{IN}-V_{OUT}=2V		5 **10**	20 **35**	mV
Dropout Voltage	V_{DROP}	I_{OUT}=1.5A, ΔV_{REF}=1%		1.3	1.5	V
Current Limit	I_{LIMIT}	V_{IN}-V_{OUT}=2V	1.5	2.3		A
Minimum Load Current	I_{LOAD}(MIN)	1.4V≤V_{IN}-V_{OUT}≤10V (For ADJ)		**2**	**5**	mA
Quiescent Current	I_Q	V_{IN}=V_{OUT}+1.3V		**5**	**10**	mA
Ripple Rejection	PSRR	f_{RIPPLE}=120Hz, C_{OUT}=25μF Tantalum, I_{OUT}=1.5A, V_{IN}-V_{OUT}=3V	**60**	**75**		dB
Adjust Pin Current	I_{ADJ}			60	**120**	μA
Adjust Pin Current Change	ΔI_{ADJ}	10mA≤I_{OUT}≤1.5A, 1.4V≤V_{IN}-V_{OUT}≤10V		**0.2**	**5**	μA
Temperature Stability				**0.5**		%
RMS Noise (% of V_{OUT})		T_A=25°C, 10Hz≤f≤10kHz		0.003		%
Thermal Shutdown		Junction Temperature		165		°C
Thermal Shutdown Hysteresis				30		°C

Note 3: Maximum power dissipation see Figure 5.

Typical Performance Characteristics

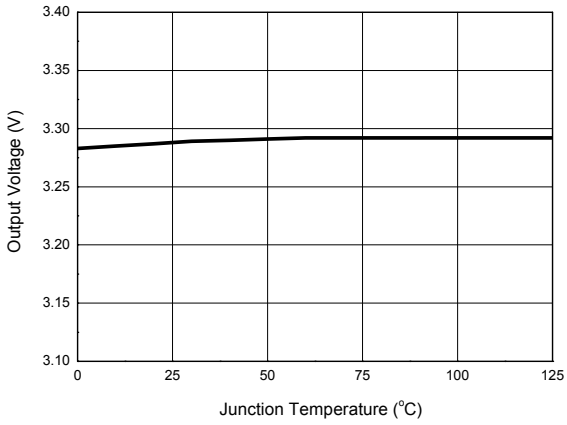


Figure 4. Output Voltage vs. Junction Temperature

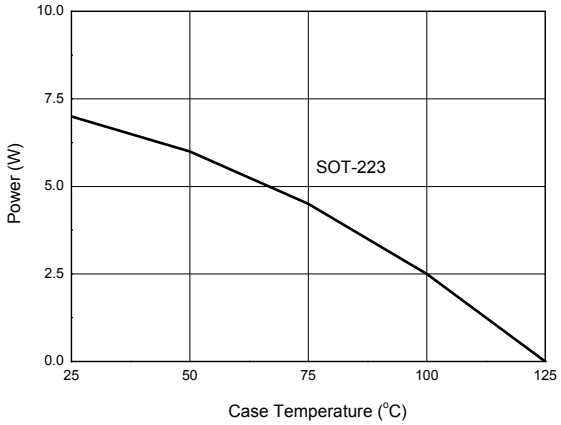


Figure 5. Maximum Power Dissipation

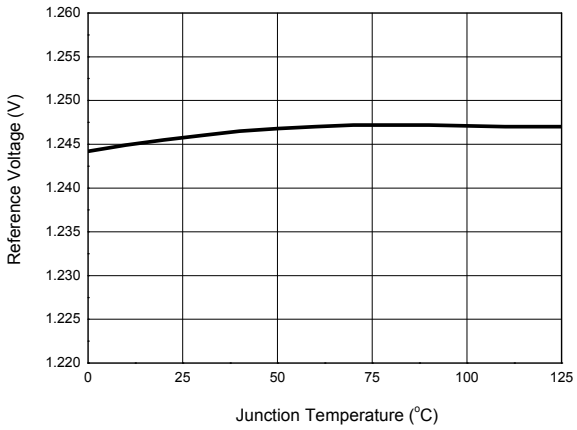


Figure 6. Reference Voltage vs. Junction Temperature

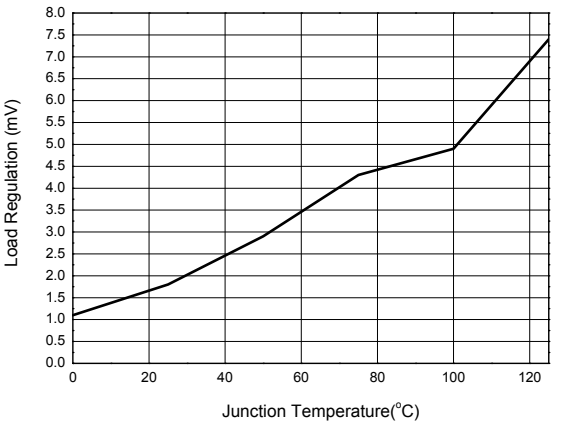


Figure 7. Load Regulation vs. Junction Temperature

Typical Performance Characteristics (Continued)

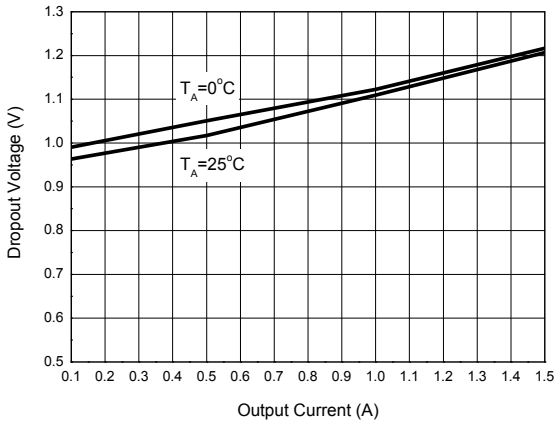


Figure 8. Dropout Voltage vs. Output Current

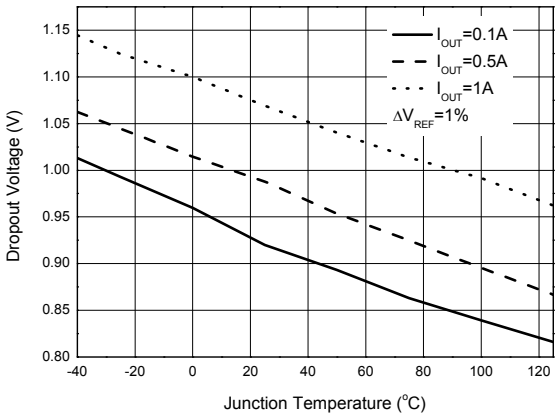


Figure 9. Dropout Voltage vs. Junction Temperature

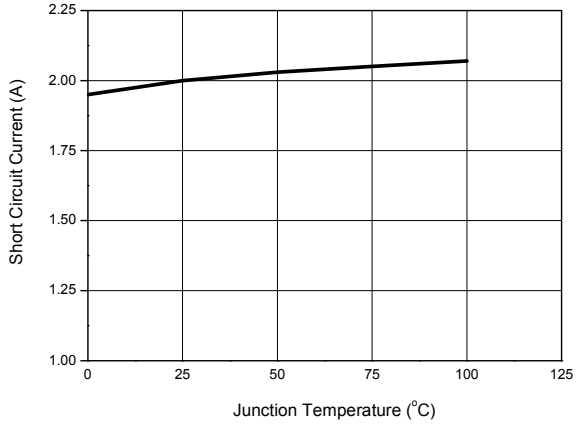


Figure 10. Short Circuit Current vs. Junction Temperature

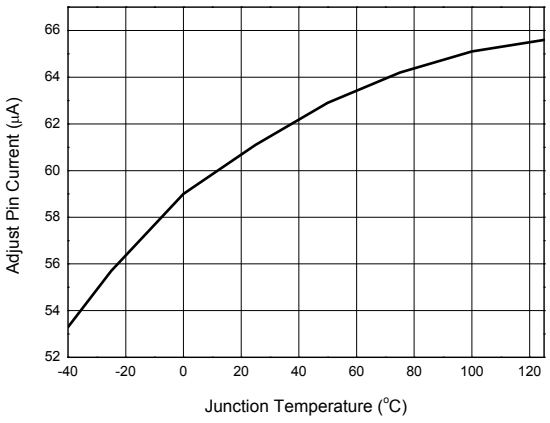


Figure 11. Adjust Pin Current vs. Junction Temperature

Typical Performance Characteristics (Continued)

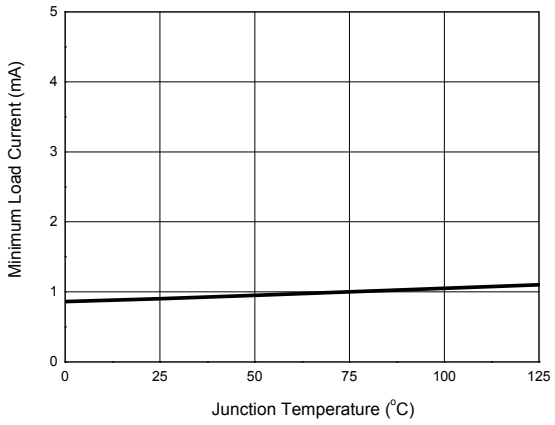


Figure 12. Minimum Load Current vs. Junction Temperature

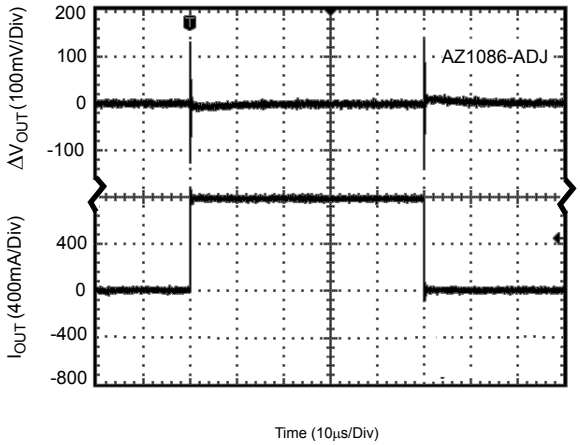


Figure 13. Load Transient Response
(Conditions: V_{IN}=4.8V, V_{OUT}=3.3V, I_{OUT}=0.1 to 0.75A, C_{IN}=C_{OUT}=10μF)

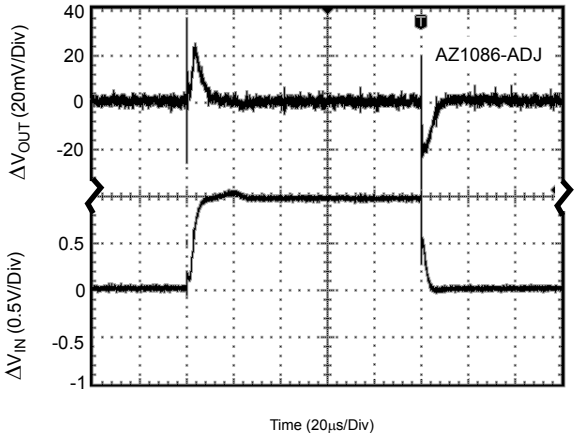


Figure 14. Line Transient Response
(Conditions: V_{IN}=4.8V to 5.8V, V_{OUT}=3.3V, I_{OUT}=0.1A, C_{IN}=1μF, C_{OUT}=10μF)

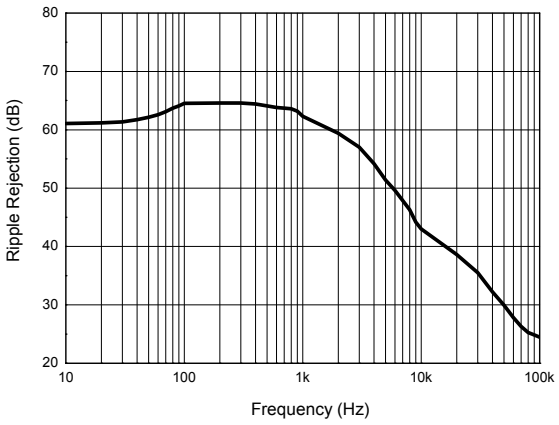


Figure 15. Ripple Rejection vs. Frequency

Typical Application

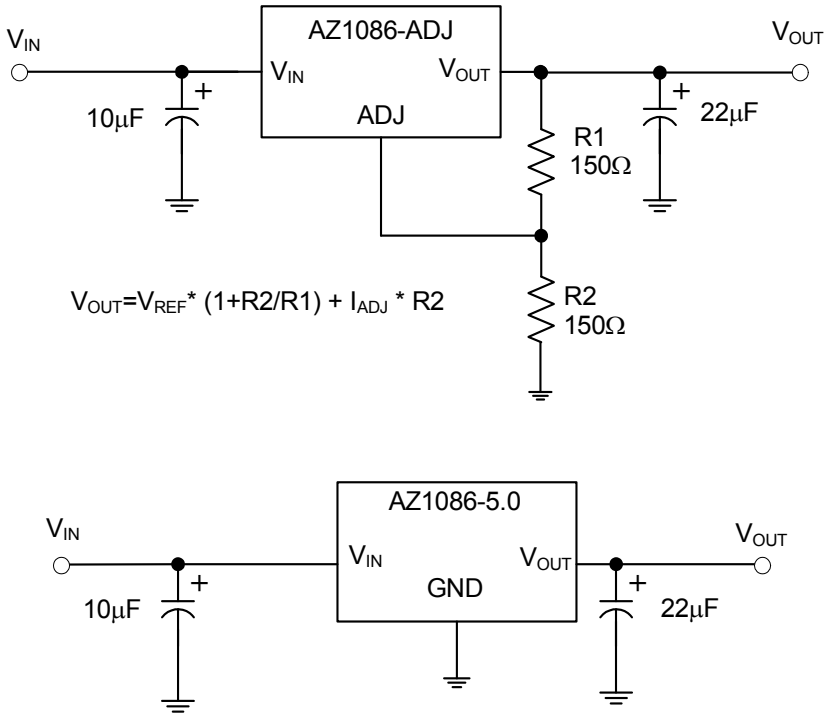
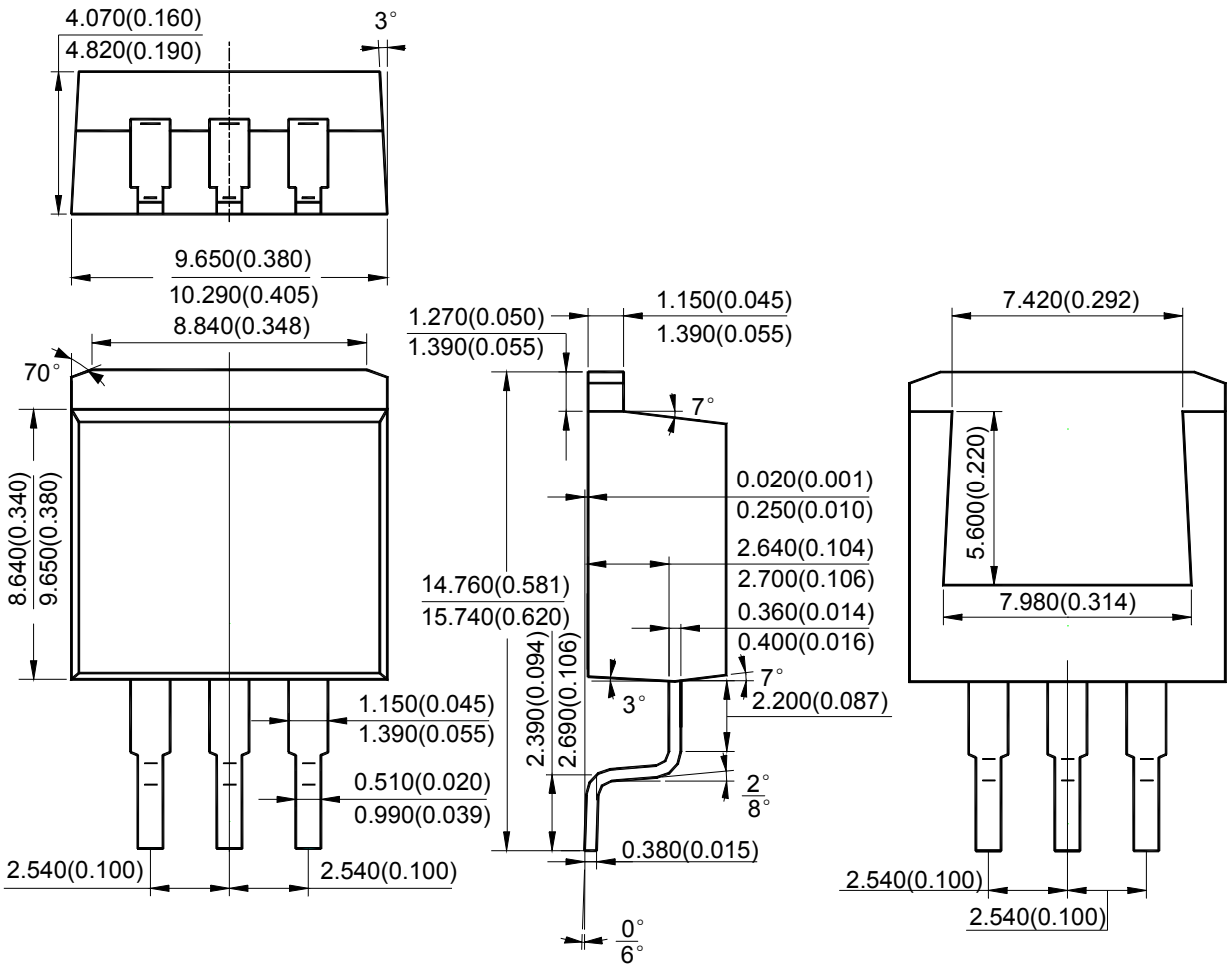


Figure 16. Typical Applications of AZ1086

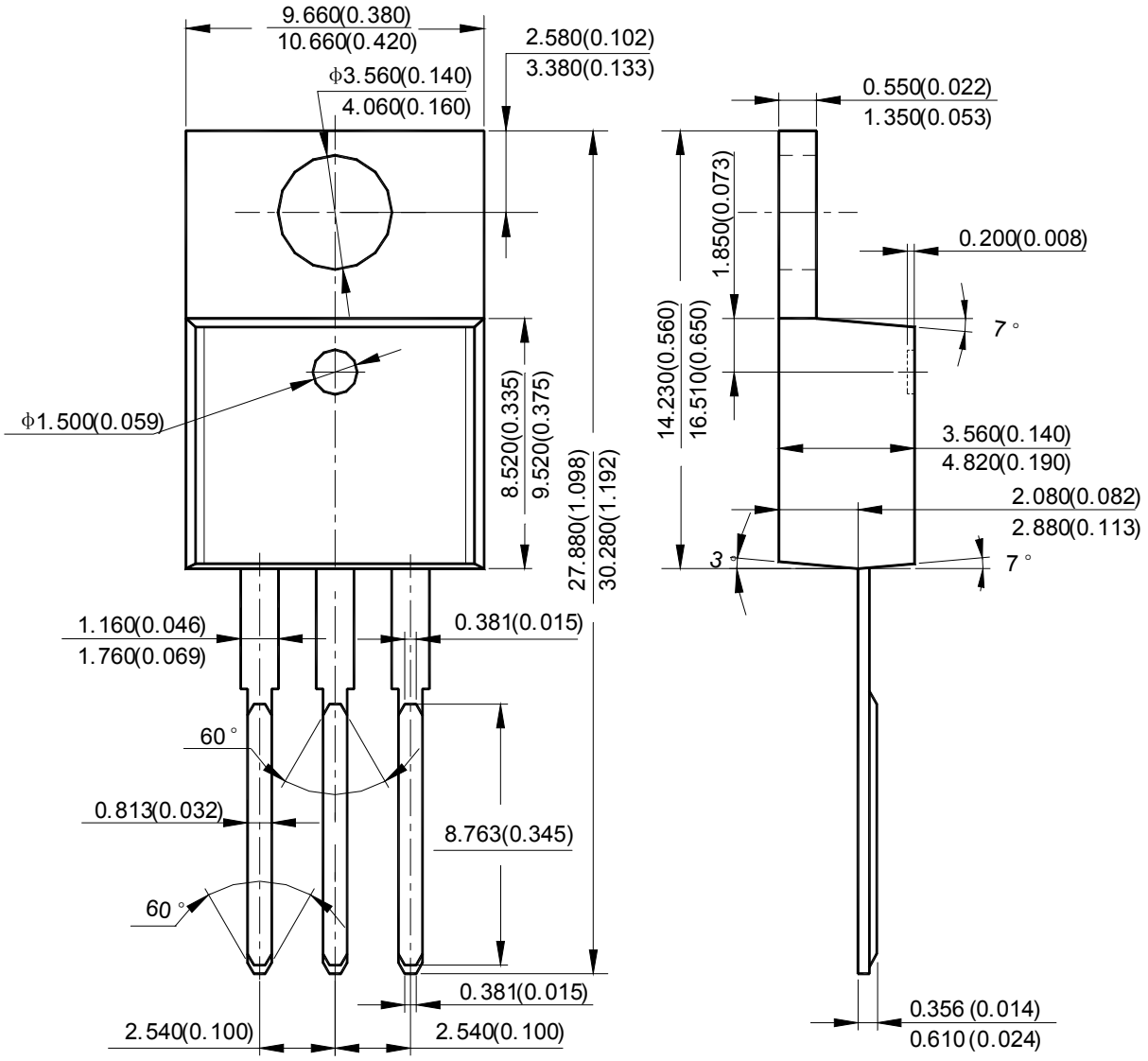
Mechanical Dimensions

TO-263-3 **Unit: mm(inch)**



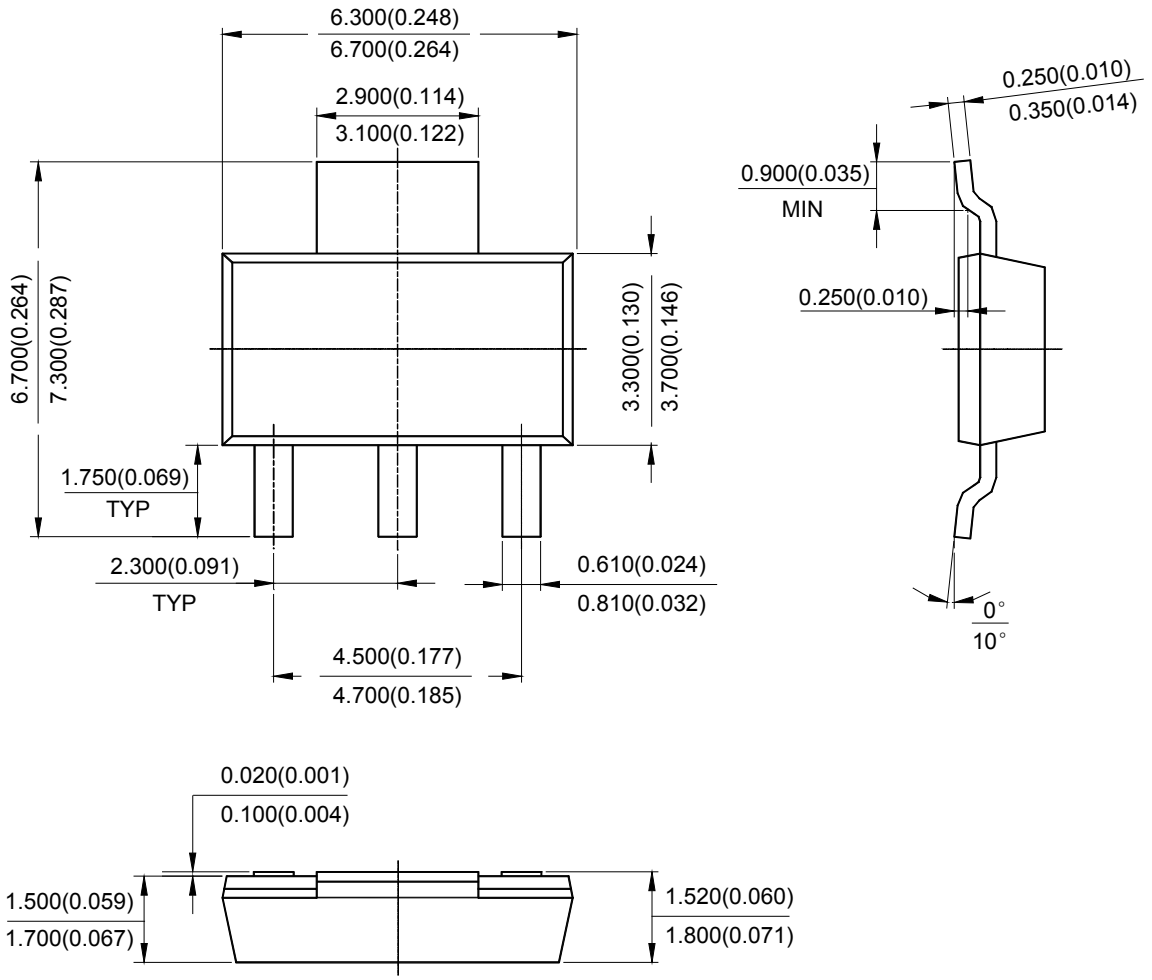
Mechanical Dimensions (Continued)

TO-220-3 **Unit: mm(inch)**



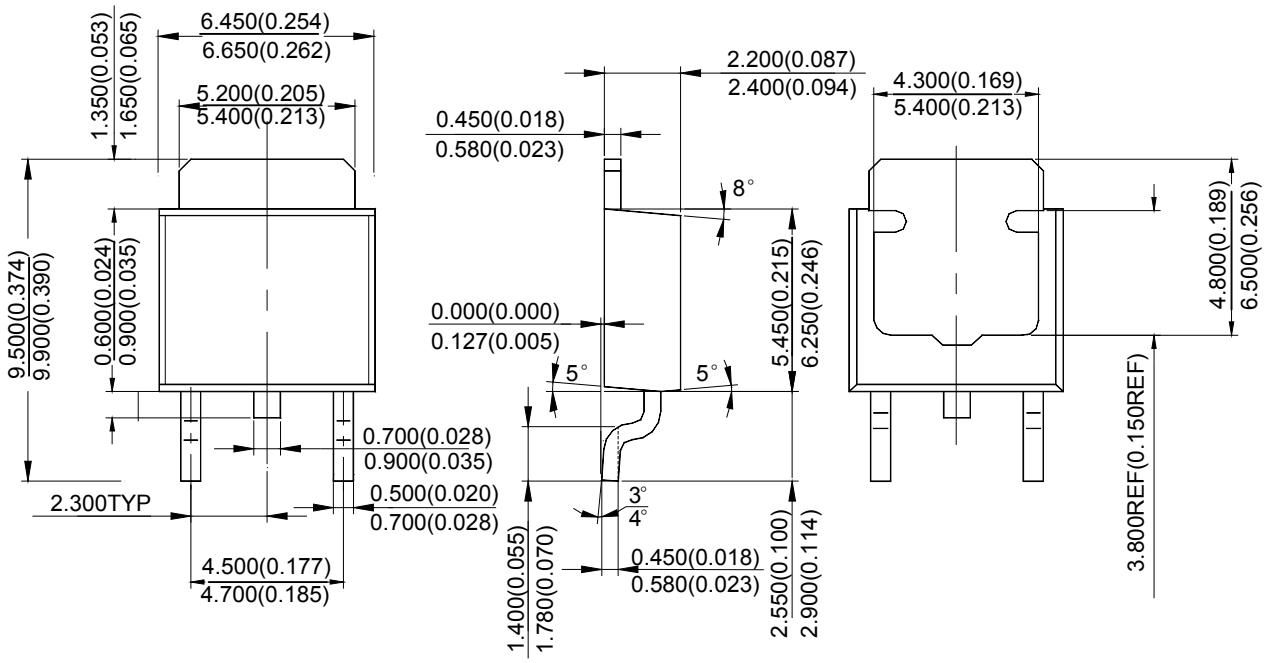
Mechanical Dimensions (Continued)

SOT-223 **Unit: mm(inch)**



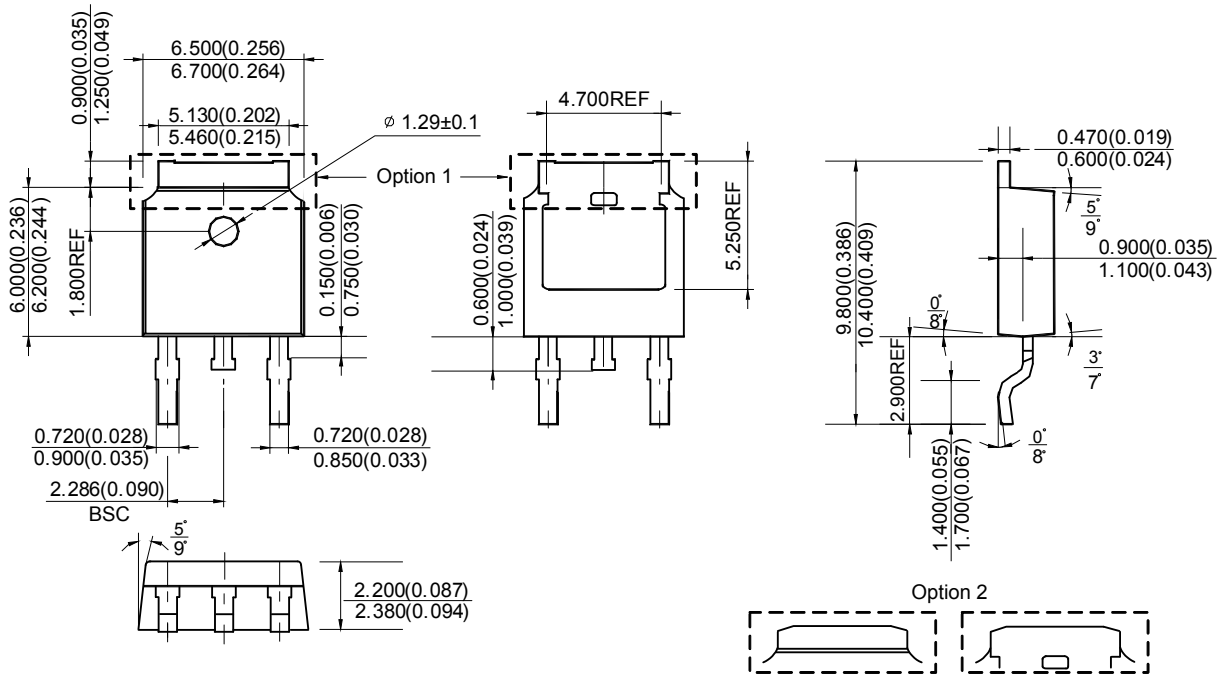
Mechanical Dimensions (Continued)

TO-252-2 (1) **Unit: mm(inch)**



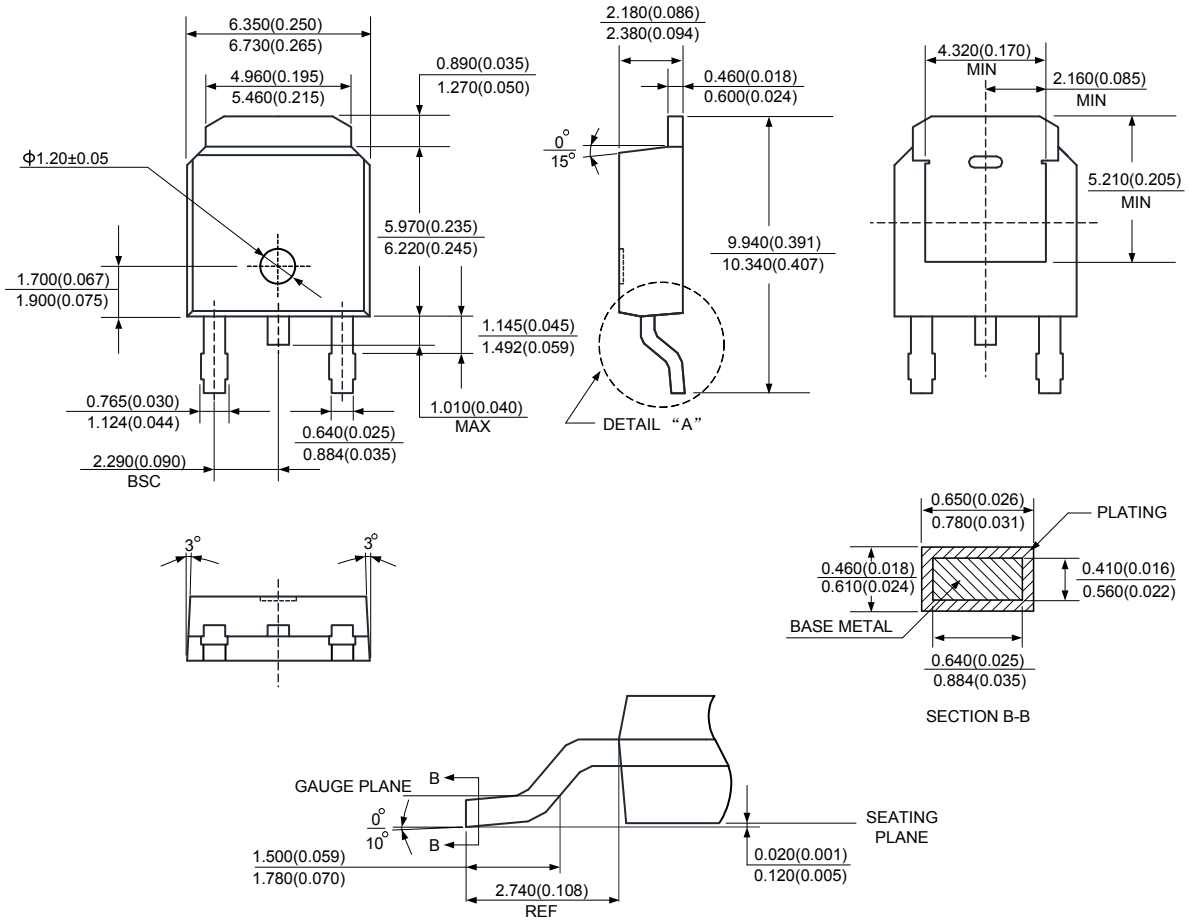
Mechanical Dimensions (Continued)

TO-252-2 (3) **Unit: mm(inch)**



Mechanical Dimensions (Continued)

TO-252-2 (4) **Unit: mm(inch)**



BCD Semiconductor Manufacturing Limited

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